

BOXER-8230AI

Compact Fanless Embedded AI@Edge Box PC with NVIDIA® Jetson™ TX2 NX User's Manual 1st Ed

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Packing List

Before setting up your product, please make sure the following items have been shipped:

ltem		Quantity
•	BOXER-8230AI	1
•	Power Connector	1

If any of these items are missing or damaged, please contact your distributor or sales representative immediately.

About this Document

This User's Manual contains all the essential information, such as detailed descriptions and explanations on the product's hardware and software features (if any), its specifications, dimensions, jumper/connector settings/definitions, and driver installation instructions (if any), to facilitate users in setting up their product.

Users may refer to the product page at AAEON.com for the latest version of this document.

BOXER-8230AI

Safety Precautions

Please read the following safety instructions carefully. It is advised that you keep this manual for future references

- 1. All cautions and warnings on the device should be noted.
- All cables and adapters supplied by AAEON are certified and in accordance with the material safety laws and regulations of the country of sale. Do not use any cables or adapters not supplied by AAEON to prevent system malfunction or fires.
- 3. Make sure the power source matches the power rating of the device.
- 4. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
- Always completely disconnect the power before working on the system's hardware.
- No connections should be made when the system is powered as a sudden rush of power may damage sensitive electronic components.
- If the device is not to be used for a long time, disconnect it from the power supply to avoid damage by transient over-voltage.
- 8. Always disconnect this device from any AC supply before cleaning.
- 9. While cleaning, use a damp cloth instead of liquid or spray detergents.
- 10. Make sure the device is installed near a power outlet and is easily accessible.
- 11. Keep this device away from humidity.
- 12. Place the device on a solid surface during installation to prevent falls
- 13. Do not cover the openings on the device to ensure optimal heat dissipation.
- 14. Watch out for high temperatures when the system is running.
- 15. Do not touch the heat sink or heat spreader when the system is running
- 16. Never pour any liquid into the openings. This could cause fire or electric shock.

Preface

- As most electronic components are sensitive to static electrical charge, be sure to ground yourself to prevent static charge when installing the internal components. Use a grounding wrist strap and contain all electronic components in any static-shielded containers.
- 18. If any of the following situations arises, please the contact our service personnel:
 - i. Damaged power cord or plug
 - ii. Liquid intrusion to the device
 - iii. Exposure to moisture
 - Device is not working as expected or in a manner as described in this manual
 - v. The device is dropped or damaged
 - vi. Any obvious signs of damage displayed on the device

19. DO NOT LEAVE THIS DEVICE IN AN UNCONTROLLED ENVIRONMENT WITH TEMPERATURES BEYOND THE DEVICE'S PERMITTED STORAGE TEMPERATURES (SEE CHAPTER 1) TO PREVENT DAMAGE.

FCC Statement



This device complies with Part 15 FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received including interference that may cause undesired operation.

Caution:

There is a danger of explosion if the battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Dispose of used batteries according to the manufacturer's instructions and your local government's recycling or disposal directives.

Attention:

Il y a un risque d'explosion si la batterie est remplacée de façon incorrecte. Ne la remplacer qu'avec le même modèle ou équivalent recommandé par le constructeur. Recycler les batteries usées en accord avec les instructions du fabricant et les directives gouvernementales de recyclage.

China RoHS Requirements (CN)

产品中有毒有害物质或元素名称及含量

AAEON System

QO4-381 Rev.A0

	有毒有害物质或元素					
部件名称	铅	汞	镉	六价铬	多溴联苯	多溴二苯
	(Pb)	(Hg)	(Cd)	(Cr(VI))	(PBB)	醚(PBDE)
印刷电路板		\cap	\circ	\sim	\circ	0
及其电子组件	×	0	0	0	0	0
外部信号		\sim	\sim	\sim	\sim	0
连接器及线材	×	0	0	0	0	0
外壳	0	0	0	0	0	0
中央处理器	~	\cap	\cap	\cap	\bigcirc	\bigcirc
与内存	^	0	0	0	0	0
硬盘	×	0	0	0	0	0
液晶模块	×	×	0	0	0	0
光驱	×	0	0	0	0	0
触控模块	×	0	0	0	0	0
电源	×	0	0	0	0	0
电池	×	0	0	0	0	0

本表格依据 SJ/T 11364 的规定编制。

○:表示该有毒有害物质在该部件所有均质材料中的含量均在

GB/T 26572标准规定的限量要求以下。

×:表示该有害物质的某一均质材料超出了GB/T 26572的限量要求,然而该部件

仍符合欧盟指令2011/65/EU 的规范。

备注:

一、此产品所标示之环保使用期限,系指在一般正常使用状况下。

二、上述部件物质中央处理器、内存、硬盘、光驱、电源为选购品。

三、上述部件物质液晶模块、触控模块仅一体机产品适用。

Hazardous and Toxic Materials List

AAEON System

QO4-381 Rev.A0

	Hazardous or Toxic Materials or Elements					
Component Name	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominat ed biphenyls (PBBs)	Polybrominat ed diphenyl ethers (PBDEs)
PCB and	V	\bigcirc	\cap	\cap	0	0
Components	~	0	0	0	0	0
Wires &						
Connectors for	Х	0	0	0	0	0
Ext.Connections						
Chassis	0	0	0	0	0	0
CPU & RAM	Х	0	0	0	0	0
HDD Drive	Х	0	0	0	0	0
LCD Module	Х	Х	0	0	0	0
Optical Drive	Х	0	0	0	0	0
Touch Control	V	\circ	0	0	0	0
Module	^	0	0	0	0	0
PSU	Х	0	0	0	0	0
Battery	Х	0	0	0	0	0

This form is prepared in compliance with the provisions of SJ/T 11364.

O: The level of toxic or hazardous materials present in this component and its parts is below the limit specified by GB/T 26572.

X: The level of toxic of hazardous materials present in the component exceed the limits specified by GB/T 26572, but is still in compliance with EU Directive 2011/65/EU (RoHS 2).

Notes:

1. The Environment Friendly Use Period indicated by labelling on this product is applicable only to use under normal conditions.

2. Individual components including the CPU, RAM/memory, HDD, optical drive, and PSU are optional.

3. LCD Module and Touch Control Module only applies to certain products which feature these components.

Table of Contents

Chapter 1 -	Chapter 1 - Product Specifications1					
1.1	Specific	ations	2			
1.2	Product	Notice	4			
Chapter 2 –	Hardwa	re Information	5			
2.1	Dimens	ions	6			
2.2	Jumper	s and connectors	8			
2.3	List of J	umpers	9			
	2.3.1	Setting Jumpers	9			
	2.3.2	AT/ATX Mode Select (CN14 Pins 7-8)	10			
2.4	List of C	Connectors	11			
	2.4.1	DC Power In Connector (CN1)	12			
	2.4.2	LAN RJ45 Port (CN2/CN3/CN4/CN5/CN6)	12			
	2.4.3	USB 2.0 Connector for Flash Image (CN7)	13			
	2.4.4	Jetson TX2 NX CPU Module Connector (CN11)	14			
	2.4.5	RTC Battery Connector (CN13)	16			
	2.4.6	Front Panel Connector (CN14)	16			
	2.4.7	HDMI Connector (CN16)	17			
	2.4.8	USB 3.0 Connector (CN17/18)	18			
	2.4.9	COM Port Connector (CN19/20)	19			
	2.4.10	SATA Connector (CN25)	20			
2.5	Hardwa	re Assembly	21			
	2.5.1	Chassis Assembly	21			
	2.5.2	Wall-mount Assembly	23			
	2.5.3	2.5" SATA Drive Assembly (A4 SKU)	24			
Chapter 3 –	OS Flasl	n Guide	. 25			
3.1	Flash O	S Image to System	26			

	3.1.1	Introduction	.26
	3.1.2	Before You Begin	.27
	3.1.3	Flash Image to Board	.28
Appendi	x A – Glue I	Removal Procedure	. 30
Α.	1 Remov	ing Glue from Your System	31

Chapter 1

Product Specifications

1.1 Specifications

System	
AI Accelerator	NVIDIA® Jetson™ TX2 NX
CPU	NVIDIA® Denver 2 (Dual-Core) Processor &
	ARM® Cortex® -A57 MPCore (Quad-Core)
	Processor
System Memory	4GB 128-bit LPDDR4 @ 1600 MHz
Storage Device	eMMC 5.1 16GB
	Micro SD card slot x 1
	2.5" SATA drive bay x 1 (A4 SKU only)
Display Interface	HDMI Type A x 1 for HDMI 2.0
Ethernet	RJ-45 x 5 for GbE LAN
I/O	USB Type A x 4 for USB3.2 Gen 1
	DB-9 x 2 for RS-232
	HDMI Type A x 1 for HDMI 2.0
	microSD slot x 1
	Micro USB x 1 for O.S Flash
	Recovery button x 1
	Power button with power LED x 1
	Antenna opening x 2
Expansion	SATA III Port x 1 for 2.5" drive (A4 SKU only)
Indicator	Power LED x 1
OS Support	Ubuntu 18.04 with NVIDIA JetPack 4.5.1

Power Supply	
Power Requirement	DC 10V~24V 2-pin terminal block ATX mode
Mechanical	
Mounting	Wall mount kit
Dimensions (W x D x H)	A3 SKU: 6.92" x 3.94" x 1.54" (175.8mm x
	100.0mm x 39.0mm)
	A4 SKU: 6.92" x 3.94" x 2.41" (175.8mm x
	100.0mm x 61.3mm)
Gross Weight	A3 SKU: 2.9 lbs. (1.3kg)
	A4 SKU: 3.5 lbs. (1.6kg)
Net Weight	A3 SKU: 1.5 lbs. (0.67kg)
	A4 SKU: 2.0 lbs. (0.91kg)
Environmental	
Operating Temperature	A3 SKU: -13°F ~ 149°F (-25°C ~ 65°C) according
	to IEC60068-2 with 0.5 m/s airflow
	A4 SKU: -13°F ~ 158°F (-25°C ~ 70°C) according
	to IEC60068-2 with 0.5 m/s airflow

Storage Humidity

Anti-Vibration

Anti-Shock

Drop Testing Certification

68 'itn 0.5 r -40°F ~ 176°F (-40°C ~ 80°C) Storage Temperature 5 ~ 95% @ 40°C, non-condensing 3.5Grm / 5~500Hz / operation (eMMC, MicroSD, or SSD) 50G peak acceleration (11 msec. duration, eMMC, microSD, or SSD) 76 cm (1 corner, 3 edge, 6 surface)

1.2 Product Notice

Micro-USB: Micro-USB port is intended for flashing image only.

USB ports: USB ports do not support USB DVD-ROM because of file system. **Model Differences:** The BOXER-8230AI has two model SKUs, the BOXER-8230AI-A3 and BOXER-8230AI-A4, referenced as A3 SKU and A4 SKU, respectively. The key difference in the models is the A4 SKU features a 2.5" SATA drive bay and taller fins for heat dispersal, making the system taller overall than the A3 SKU. The A3 SKU lacks the drive bay and features shorter fins, making the system more compact. If you are still unsure which model SKU you have, contact your AAEON representative for assistance.

LAN Indicator Behavior



Chapter 2

Hardware Information

2.1 Dimensions











BOXER-8230AI-A4



¥

2.2 Jumpers and connectors



2.3 List of Jumpers

The board has a number of jumpers that allow you to configure your system to suit your application.

The table below shows the function of each of the board's jumpers

Label	Function
CN14 (Pin 7-8)	AT/ATX mode select

2.3.1 Setting Jumpers

You can configure your system to match the needs of your application by setting jumpers. A jumper is the simplest kind of electric switch. It consists of two metal pins and a small metal clip (often protected by a plastic cover) that slides over the pins to connect them. To "close" a jumper you connect the pins with the clip. To "open" a jumper you remove the clip. Sometimes a jumper will have three pins,

labeled 1, 2 and 3. In this case you would connect either pins 1 and 2 or 2 and 3.



A pair of needle-nose pliers may be helpful when working with jumpers.

If you have any questions about the best hardware configuration for your application,

contact your local distributor or sales representative before you make any changes.

Generally, you simply need a standard cable to make most connections.

The AT/ATX Mode Select functions by connecting pins 7 and 8 of CN14. To prevent damage to the system, do not connect pins 7 and 8 to any other pin.



Open – AT Mode

Closed – ATX Mode (Default)

8

CN14 pins 7-8	Function
7-8 Open	AT Power Mode
7-8 Closed	ATX Power Mode (Default)

2.4 List of Connectors

The board has a number of connectors that allow you to configure your system to suit your application.

The table below shows the function of each of the board's connectors

Label	Function			
CN1	DC Power In Connector			
CN2	Jetson TX2 NX Gigabit LAN Connector			
CN3	i210AT Gigabit LAN Connector			
CN4	i210AT Gigabit LAN Connector			
CN5	i210AT Gigabit LAN Connector			
CN6	i210AT Gigabit LAN Connector			
CN7	USB2.0 Connector for Flash Image			
CN8	USB2.0 Connector			
CN9	FAN Connector			
CN11	Jetson TX2 NX CPU module connector			
CN13	RTC Battery Connector			
CN14	Front Panel Connector			
CN15	Debug UART/I2C			
CN16	HDMI connector			
CN17	USB3.0 Connector			
CN18	USB3.0 Connector			
CN19	COM 1 Connector (/dev/THS1)			
CN20	COM 2 Connector (/dev/THS0)			
CN23	GPIO Connector			
CN25	SATA Connector (A4 SKU Only)			
CN32	SATA Power Connector (A4 SKU Only)			
SW1	Power Switch			

Label	Function
SW2	Recovery Switch
SW3	Reset Switch

2.4.1 DC Power In Connector (CN1)



Pin	Signal	Pin	Signal
1	PWR IN	2	GND

2.4.2 LAN RJ45 Port (CN2/CN3/CN4/CN5/CN6)



Pin	Signal	Pin	Signal
1	MDI0+	2	MDI0-
3	MDI1+	4	MDI1-
5	MDI2+	6	MDI2-
7	MDI3+	8	MDI3-

Note: CN2 is the Jetson TX2 NX Gigabit LAN port. Ports CN3, CN4, CN5, and CN6 are i210AT Gigabit LAN Ports.



USB Micro-B

Pin	Signal	Pin	Signal
1		2	USB1-
3	USB1+	4	
5	GND		

2.4.4 Jetson TX2 NX CPU Module Connector (CN11)

Module Signal Name	Pin #		Pin #	Module Signal Name
CND	1		2	CND
CSI1 DO N	3		4	CSID DO N
CSI1 D0 P	5		6	CSIO DO P
GND	7		8	GND
CSI1 CLK N	9		10	CSIO, CLK, N
CSI1 CLK P	11		12	CSIO CLK P
GND	13		14	GND
CSI1 D1 N	15		16	CSIO D1 N
CSI1 D1 P	17	i i	18	CSIO D1 P
GND	19		20	GND
CSI3 D0 N	21		22	CSI2 D0 N
CSI3 D0 P	23		24	CSI2 D0 P
GND	25		26	GND
CSI3 CLK N	27		28	CSI2 CLK N
CSI3 CLK P	29		30	CSI2 CLK P
GND	31		32	GND
CSI3 D1 N	33		34	CSI2 D1 N
CSI3 D1 P	35		36	CSI2 D1 P
GND	37		38	GND
DP0 TXD0 N	39		40	CSI4 D2 N
DP0 TXD0 P	41		42	CSI4 D2 P
GND	43		44	GND
DP0 TXD1 N	45		46	CSI4 D0 N
DPO TXD1 P	47		48	CSI4 DO P
GND	49		50	GND
DP0 TXD2 N	51		52	CSI4 CLK N
DP0 TXD2 P	53		54	CSI4 CLK P
GND	55		56	GND
DP0 TXD3 N	57		58	CSI4 D1 N
DP0 TXD3 P	59		60	CSI4 D1 P
GND	61		62	GND
DP1 TXD0 N	63		64	CSI4 D3 N
DP1 TXD0 P	65		66	CSI4 D3 P
GND	67		68	GND
DP1 TXD1 N	69		70	DSI DO N
DP1 TXD1 P	71		72	DSI DO P
GND	73		74	GND
DP1 TXD2 N	75		76	DSI CLK N

Module Signal Name	Pin #	Pin #	Module Signal Name
DP1 TXD2 P	77	78	DSI CLK P
GND	79	80	GND
DP1 TXD3 N	81	82	DSI D1 N
DP1 TXD3 P	83	84	DSI D1 P
GND	85	86	GND
GPIO00	87	88	DP0 HPD
SPI0 MOSI	89	90	DPO AUX N
SPI0 SCK	91	92	DPO AUX P
SPI0 MISO	93	94	HDMI CEC
SPI0 CSO*	95	96	DP1 HPD
SPI0 CS1*	97	98	DP1 AUX N
UARTO TXD	99	100	DP1 AUX P
UARTO RXD	101	102	GND
UARTO RTS*	103	104	SPI1 MOSI
UARTO CTS*	105	106	SPI1 SCK
GND	107	108	SPI1 MISO
USBO D N	109	110	SPI1 CSO*
USBO D P	111	112	SPI1 CS1*
GND	113	114	CAMO PWDN
USB1 D N	115	116	CAM0 MCLK
USB1 D P	117	118	GPIO01
GND	119	120	CAM1 PWDN
USB2 D N	121	122	CAM1 MCLK
USB2 D P	123	124	GPIO02
GND	125	126	GPIO03
GPIO04	127	128	GPIO05
GND	129	130	GPIO06
PCIEO RXO N	131	132	GND

Module Signal Name	Pin #	Pin #	Module Signal Name
PCIEO RXO P	133	134	PCIEO TXO N
GND	135	136	PCIEO TXO P
PCIEO RX1 N	137	138	GND
PCIEO RX1 P	139	140	PCIE0 TX1 N
GND	141	142	PCIEO TX1 P
(CAN RX) RSVD	143	144	GND
KEY	KEY	KEY	KEY
(CAN_TX) RSVD	145	146	GND
GND	147	148	PCIE0 TX2 N
PCIEO RX2 N	149	150	PCIE0 TX2 P
PCIEO RX2 P	151	152	GND
GND	153	154	PCIE0 TX3 N
PCIEO RX3 N (RSVD)	155	156	PCIE0 TX3 P
PCIEO RX3 P (RSVD)	157	158	GND
GND	159	160	PCIEO CLK N
USBSS RX N	161	162	PCIEO CLK P
USBSS RX P	163	164	GND
GND	165	166	USBSS TX N
(PCIE1 RX0 N) RSVD	167	168	USBSS TX P
(PCIE1 RXO P) RSVD	169	170	GND
GND	171	172	(PCIE1 TX0 N) RSVD
RSVD	173	174	(PCIE1 TX0 N) RSVD
RSVD	175	176	GND
GND	177	178	MOD SLEEP*
PCIE WAKE*	179	180	PCIEO CLKREQ*
PCIEO RST*	181	182	(PCIE1 CLKREQ*) RSVD
(PCIE1 TX0 N) RSVD	183	184	GBE MDIO N
12C0 SCL	185	186	GBE MDIO P
I2C0 SDA	187	188	GBE LED LINK
I2C1 SCL	189	190	GBE MDI1 N
I2C1 SDA	191	192	GBE MDI1 P
I2S0 DOUT	193	194	GBE LED ACT
I2SO DIN	195	196	GBE MDI2 N
12S0 FS	197	198	GBE MDI2 P
12S0 SCLK	199	200	GND
GND	201	202	GBE MDI3 N
UART1 TXD	203	204	GBE MDI3 P
UART1 RXD	205	206	GPIO07

Module Signal Name	Pin #	Pin #	Module Signal Name
UART1 RTS*	207	208	GPIO08
UART1 CTS*	209	210	CLK 32K OUT
GPIO09	211	212	GPIO10
CAM I2C SCL	213	214	FORCE RECOVERY*
CAM I2C SDA	215	216	GPIO11
GND	217	218	GPIO12
SDMMC DATO	219	220	I2S1 DOUT
SDMMC DAT1	221	222	I2S1 DIN
SDMMC DAT2	223	224	12S1 FS
SDMMC DAT3	225	226	I2S1 SCLK
SDMMC CMD	227	228	GPIO13
SDMMC CLK	229	230	GPIO14
GND	231	232	I2C2 SCL
SHUTDOWN REQ*	233	234	I2C2 SDA
PMIC BBAT	235	236	UART2 TXD
POWER EN	237	238	UART2 RXD
SYS RESET*	239	240	SLEEP/WAKE*
GND	241	242	GND
GND	243	244	GND
GND	245	246	GND
GND	247	248	GND
GND	249	250	GND
VDD IN	251	252	VDD IN
VDD IN	253	254	VDD IN
VDD IN	255	256	VDD IN
VDD IN	257	258	VDD IN
VDD IN	259	260	VDD IN

Power

Legend

Reserved - must be left unconnected

Ground

2.4.5 RTC Battery Connector (CN13)



2.4.6 Front Panel Connector (CN14)

1		2
3		4
5		6
7		8
9		10

Pin	Signal	Pin	Signal
1	Power Button	2	GND
3	Recovery	4	GND
5	Reset	6	GND
7	Latch Set	8	Latch Set
9	PWR LED	10	+5V

Note: Pin 7 and 8 are used for setting AT/ATX Power Mode. See **Chapter 2.3.2** for information. To prevent damage to your system, do not connect Pins 7 and 8 with any other pin.

2.4.7 HDMI Connector (CN16)



Pin	Signal	Pin	Signal
1	HDMI_DATA2_P	2	GND
3	HDMI_DATA2_N	4	HDMI_DATA1_P
5	GND	6	HDMI_DATA1_N
7	HDMI_DATA0_P	8	GND
9	HDMI_DATA0_N	10	HDMI_CLK_P
11	GND	12	HDMI_CLK_N
13	NC	14	NC
15	HDMI_SCL	16	HDMI_SDA
17	GND	18	HDMI_PWR
19	HDMI_HDP		



Pin	Signal	Pin	Signal
U1	VBUS_1	U10	VBUS_2
U2	(A)D-	U11	(B)D-
U3	(A)D+	U12	(B)D+
U4	GND	U13	GND
U5	(A)SSRX-	U14	(B)SSRX-
U6	(A)SSRX+	U15	(B)SSRX+
U7	GND	U16	GND
U8	(A)SSTX-	U17	(B)SSTX-
U9	(A)SSTX+	U18	(B)SSTX+



Pin	RS-232	TTL UART
1		
2	RXD	
3	TXD	
4		
5	GND	
6		
7	RTS	
8	CTS	
9		

Note: When using UART mode, RS-232 Receiver U21, U22 must be removed.

SATA Pinout - Plug

1	2	3	4	5	6	7
- GND	A+ h	-A-	GND -	B-	B+ 0	, GND

Pin	Signal	Pin	Signal
1	GND	2	SATA TX+
3	SATA TX-	4	GND
5	SATA RX-	6	SATA RX+
7	GND		

Note: SATA Connector is a feature only for the A4 SKU model.

2.5 Hardware Assembly

2.5.1 Chassis Assembly











Chapter 3

OS Flash Guide

3.1 Flash OS Image to System

3.1.1 Introduction

This chapter details the steps to flashing the operating system to your BOXER-8230AI NVIDIA Jetson TX2 NX system. The operating system image can be downloaded from the product page at:

https://www.aaeon.com/en/p/ai-edge-jetson-tx2-nx-boxer-8230ai

After downloading the file, the filename will be formatted as follows:

Ubuntu_18.04_{OS_IF}.{PLF_IF}.{PJ_IF}.{BN}.tar.gz

{OS_IF} is OS Information. For example, the entry UB1804X decodes as UB for Ubuntu, 1804 for version 18.04, and X for desktop version.

{PLF_IF} is Platform Information and may be coded as NV06.

{PJ_IF} is Project Information and displays which model this image pertains to. Make sure it says BOXER-8230AI.

{BN} is Build Number, such as 0, 1, 2, 3 and so on.

For example, build number 4 will be named as:

Ubuntu_18.04_UB1804X.NV06.BOXER-8230AI.4.tar.gz

If you have any questions or need help, please contact AAEON support or your AAEON representative for assistance.

3.1.2 Before You Begin

Before beginning the process ensure you have the following:

- One host PC with operating system Ubuntu 16.04 or 18.04
- Operating System image downloaded to host computer
- USB Cable with Micro USB connector
- Jetson TX2 NX module; see image below for reference:



Finally, on the Linux host PC, extract the image file you downloaded using the following command in terminal (remember to replace {""} with the actual file name):

\$ tar xzf Ubuntu_18.04_{OS_IF}.{PLF_IF}.{PJ_IF}.{BN}.tar.gz

3.1.3 Flash Image to Board

Step 1: Connect the host PC to the BOXER-8230AI with a Micro USB cable.

Step 2: Connect the BOXER-8230AI carrier board to the power supply.

Step 3: Force Recovery Mode: Press and hold the recovery key, then press the power key. After 2 seconds, release the recovery key. The BOXER-8230AI should enter recovery mode.



Step 5: You can use Isusb command on host PC to check if the device is in recovery mode:

\$ lsusb | grep 0955:7c18

The system will return the following when in recovery mode: 0955:7c18 Nvidia Corp

Step 6: In terminal, enter the bootloader folder that you unzipped earlier.

Step 7: Run the following command to flash the image:

\$ sudo ./flashall.sh

Step 8: Wait for the process to complete.

293.2436]	Writing partition bpmp-fw-dtb with tegra194-a02-bpmp-p3668-a00 sigheader.dtb.encrypt		
303.9612]	[] 100%		
303.9665]	Writing partition bpmp-fw-dtb_b with tegra194-a02-bpmp-p3668-a00_sigheader.dtb.encrypt		
306.1408]	[] 100%		
306.1458]	Writing partition VER with gspl_bootblob_ver.txt		
308.3194]	[] 100%		
308.3208]	Writing partition VER_b with qspi_bootblob_ver.txt		
308.3323]	[] 100%		
308.3342]	Writing partition master_boot_record with mbr_1_3.bin		
308.3448]	[] 100%		
308.3460]	Writing partition APP with system.img		
308.3520]	[] 100%		
1182.8634] Writing partition kernel with boot_sigheader.img.encrypt		
1182.8639] [] 100%		
1189.4815] Writing partition kernel_b with boot_sigheader.img.encrypt		
1189.5005] [] 100%		
1191.1915] Writing partition kernel-dtb with tegra194-p3668-all-p3809-0000_sigheader.dtb.encrypt		
1191.2108			
1191.4403	j writing partition kernet-oto_b with tegral94-psoos-att-pssog-oboo_stgneader.otb.encrypt		
1191.4504	1 [] 1998		
1102 1310	J tearadeuflach v2vrite BCT br brt BD brt		
1192 1328	Bootlader version 81 08 0800		
1192.6810	Writing partition BCT with br het BR het		
1192.6919	1 100K		
1192,9400			
1192,9972	1 tegradevflash v2write MB1 BCT mb1 cold boot bct MB1 sigheader.bct.encrypt		
1192.9984	1 Bootloader version 01.00.0000		
1193.5449	Writing partition MB1 BCT with mb1 cold boot bct MB1 sigheader.bct.encrypt		
1193.5455	1 F		
1194.1843			
1194.1856	1 tegradevflash v2write MB1 BCT b mb1 cold boot bct MB1 sigheader.bct.encrypt		
1194.1866] Bootloader version 01.00.0000		
1194.7332] Writing partition MB1_BCT_b with mb1_cold_boot_bct_MB1_sigheader.bct.encrypt		
1194.7340] [] 100%		
1195.1284	1		
1195.1370] tegradevflash_v2write MEM_BCT mem_coldboot_sigheader.bct.encrypt		
1195.1379] Bootloader version 01.00.0000		
1195.6850] Writing partition MEM_BCT with mem_coldboot_sigheader.bct.encrypt		
1195.6855] [] 100%		
1198.2719			
1198.2730] tegradevilasn_v2write MEM_BCI_D Mem_Coldboot_signeader.bct.encrypt		
1198.2738] Bootloader version 01.00.0000		
1198.8211	j writing partition MEM_BCI_D with MeM_coldboot_signader.bct.encrypt		
1198.821/	1 [] 100x		
1201.3157	J Flaching completed		
1201.3136	j reasing completed		
1201-3160	1 Coldbooting the device		
1201.5699	1 tegrarcm v2ismb2		
1202.8176			
1202.8199	1 tegradevflash v2reboot coldboot		
1202.8221	1 Bootloader version 01.00.0000		
1203.3858 Ĵ			
** The target t186ref has been flashed successfully. ***			
eset the board to boot from internal eMMC.			

Appendix A

Glue Removal Procedure

A.1 Removing Glue from Your System

To protect components from damage and ensure proper operation out of the box, glue may have been applied to some cables or connectors to keep them in place during shipping. This glue must be removed before attempting to swap components or perform maintenance. This section details the steps needed to remove the glue.

Before performing any kind of system maintenance, ensure the system is shut down (not in sleep or hibernate mode) and the power cable has been removed. Follow steps in Chapter 2 to access the components inside.

You will need the following items for this step:

- Cotton or cotton swab
- Anti-static tweezers

- An alcohol solution that is at least 99.5% alcohol (ethanol solution or denatured alcohol). AAEON recommends using an eye dropper or a bottle with a nozzle as in the picture below:



Appendix A – Glue Removal Procedure

BOXER-8230A

Step 1: Using an eyedropper or bottle as shown above, apply a few drops of alcohol to the glue.

Step 2: Allow the alcohol to soak for 10 seconds, then use a cotton swab or cotton with anti-static tweezers to evenly rub the alcohol over the glue.



Step 3: Let soak for 10 more seconds, then use anti-static tweezers to remove the glue.



If you encounter any issues or need support, please contact your AAEON representative or visit our <u>Support Page</u> at AAEON.com

Appendix A – Glue Removal Procedure